



FEATURES

TAIWAN

• Low power loss, high efficiency

IICONDUCTOR

- Ideal for automated placement
- Guard ring for overvoltage protection
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- DC to DC converters

MECHANICAL DATA

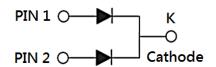
- Case: TO-263AB (D²PAK)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 1.70g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
١ _F	60	А
V _{RRM}	40	V
I _{FSM}	250	А
T _{J MAX}	150	°C
Package	TO-263AB (D ² PAK)	
Configuration	Dual d	lies





TO-263AB (D²PAK)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)			
PARAMETER	SYMBOL	MBRS6040CT	UNIT
Marking code on the device		MBRS6040CT	
Repetitive peak reverse voltage	V _{RRM}	40	V
Reverse voltage, total rms value	V _{R(RMS)}	28	V
Forward current	I _F	60	А
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	I _{FSM}	250	А
Critical rate of rise of off-state voltage	dv/dt	10,000	V/µs
Junction temperature	TJ	-55 to +150	°C
Storage temperature	T _{STG}	-55 to +150	°C



THERMAL PERFORMANCE			
PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-case thermal resistance	R _{eJC}	1	°C/W

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage per diode ⁽¹⁾	$I_F = 30A, T_J = 25^{\circ}C$	VF	-	0.75	V
	$I_F = 60A, T_J = 25^{\circ}C$		-	1.05	V
	$I_F = 30A, T_J = 125^{\circ}C$		-	0.70	V
	$I_F = 60A, T_J = 125^{\circ}C$		-	0.98	V
Reverse current @ rated V _R per diode ⁽²⁾	T _J = 25°C	I _R	-	100	μA
Reverse current is rated v _R per diode	T _J = 125°C		-	40	mA

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION		
ORDERING CODE	PACKAGE	PACKING
MBRS6040CT	TO-263AB (D ² PAK)	800 / Tape & Reel



100

10

1

0.1

0.01

0.001

10 20 30 40 50

INSTANTANEOUS REVERSE CURRENT (mA)

CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

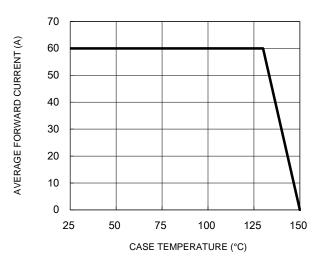


Fig.1 Forward Current Derating Curve

Fig.3 Typical Reverse Characteristics

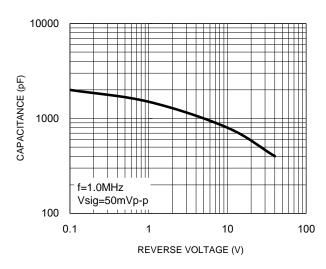
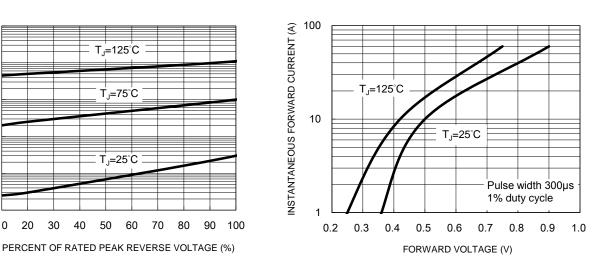


Fig.4 Typical Forward Characteristics



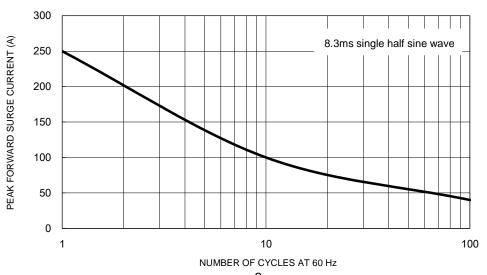


Fig.5 Maximum Non-Repetitive Forward Surge Current

Fig.2 Typical Junction Capacitance



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

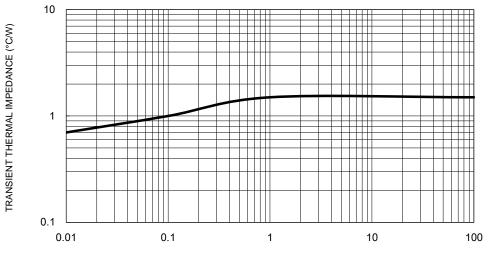
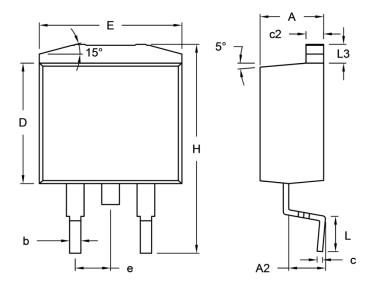


Fig.6 Typical Transient Thermal Impedance

PULSE DURATION (s)

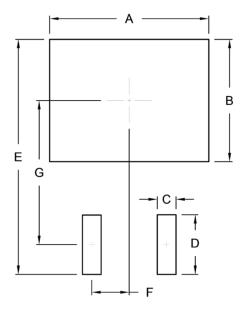
PACKAGE OUTLINE DIMENSIONS

TO-263AB (D²PAK)



DIM.	Unit (mm)		Unit ((inch)
	Min.	Max.	Min.	Max.
A	4.44	4.70	0.175	0.185
A2	2.03	2.79	0.080	0.110
b	0.68	0.94	0.027	0.037
с	0.36	0.53	0.014	0.021
c2	1.14	1.40	0.045	0.055
D	8.25	9.25	0.325	0.364
E	-	10.50	-	0.413
е	2.41	2.67	0.095	0.105
н	14.60	15.88	0.575	0.625
L	2.29	2.79	0.090	0.110
L3	1.14	1.40	0.045	0.055

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	10.80	0.425
В	8.30	0.327
С	1.27	0.050
D	4.05	0.159
E	15.95	0.628
F	2.54	0.100
G	9.775	0.385

MARKING DIAGRAM

S GYWW	
P/N	

P/N	= Marking Code
G	= Green Compound
YWW	= Date Code
F	= Factory Code



Taiwan Semiconductor

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